RECORDATIC

08-30-1999



U.S. DEPARTMENT OF COMMERCE

ef. No.: 450100-02032

		Patent and Trademark Office
To the Honorable Commissioner of Patents and Trac	demark 101129961	cuments or copy thereof.
Name of conveying party(ies)	2. Name and address	of receiving party(ies)
Tetsujiro KONDO, Yasushi TATEHIRA, Nobuyuki ASAKURA, UCHIDA, Takuo MORIMURA, Kazutaka ANDO, Hideo NAKAYA, WATANABE, Satoshi INOUE, Wataru NIITSUMA	, Tsutomu 7-3	SONY CORPORATION 35 Kitashinagawa 6-chome awa-Ku, Tokyo 100-31, Japan
Additional name(s) of conveying party(ies) attace Yes X No		address(es) attached? Yes _x No
3. Nature of conveyance:		
X Assignment Security Agreement Merger Change of Name Other		S. P.To.
Execution Date: <u>July 27, 1999</u> , <u>July 28, 1999</u> , <u>July 28</u> , 1999, <u>July 28</u> , 1999, <u>July 29</u> , 1999, <u>July 29</u> , 1999, <u>August 4, 1999</u> , <u>and August 5, 1999</u>		09/378
4. Application number(s) or patent number(s):		'n <del>==</del>
If this document is being filed to the application is: <u>July 27, 1999</u> 28, 1999, July 29, 1999, July 29, 1999	, July 28, 1999, July 28, 1999, <i>F</i>	August 4, 1999, July 1999, and August 5,
A. Patent Application No.(s) filed _ Additional n	umbers attached? Yes <u>X</u> N	091388062
5. Name and address of party to whom correspondence concerning document should be mailed:		applications and
Name: WILLIAM S. FROMMER	7. Total fee (37 CF	R 3.41) \$ 40.00
Internal Address: FROMMER LAWRENCE & HAUG LLP Street Address: 745 FIFTH AVENUE	AL	nclosed othorized to be charged to eposit account 50-0320
City: NEW YORK State: N.Y. Zip: 10151	8. Deposit account (Attach duplicate co	number: py of this page if paying by deposit
	Do not use this space	
<ol> <li>Statement and signature.         To the best of my knowledge and belief, the fore of the original document.     </li> </ol>	going information is true and cor	rect and any attached copy is a true copy
WILLIAM S. FROMMER	rai Momm	August 20, 1999
Name of Person Signing	Signature	Date Total number of pages including cover sheet, attachments, and document: 3
27/1999 MTHAI1 00000356 093/8065	not detach this portion	nformation to:
Commissi	oner of Patents and Trademarks Box Assignments Washington, D.C. 20231	
Bullion formula in the second of the second		

Public burden reporting for this sample cover sheet is estimated to average about 30 minutes per document to be recorded, including time for reviewing the document and gathering the data needed, and completing and reviewing the sample cover sheet. Send comments regarding this burden estimate to the U.S. Patent and Trademark Office, Office of Information Systems, PK2-1000C, Washington, D.C. 20231, and to the Office of Management and Budget, Paperwork Reduction Project (0651-0011), Washington, D.C. 20503.

08/

CMS Docket Number:

450100-02032

## ASSIGNMENT

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in PICTURE INFORMATION CONVERTING APPARATUS, PICTURE INFORMATION CONVERTING METHOD, AND TELEVISION RECEIVER

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filling of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorn date of this application in the spaces that follow: Serial Number	ey(s) of record in this application to insert the serial number and filing  :, Filing Date:
This assignment executed on the dates indicate	ed below.
TETSUJIRO KONDO	July 27, 199
Name of first or sole inventor	Execution date of U.S. Patent Application
TOKYO, JAPAN	
Residence of first or sole inventor	Date of this assignment
Signature of first/or sole inventor	Date of this assignment
Jasushi Tatehira Yasushi tatehira	July 28, '99
Name of second inventor	Execution date of U.S. Patent Application
KANAGAWA, JAPAN	
Residence of second inventor Jasushi Jatehore	July 28, 99 Date of this assignment
Signature of second inventor	Date of this assignment
NOBUYUKI ASAKURA	July 28 39
Name of third inventor	Execution date of U.S. Patent Application
TOKYO, JAPAN	
Residence of third inventor  Nolumber asakura	July 28 99 Date of this assignment
Signature of third inventor	Date of this assignment

ADDITIONAL INVENTOR(S) ON NEXT PAGE

Page 2 of 2

	Execution date of U.S. Patent Application
MASASHI UCHIDA	Title Process Application
Name of fourth inventor	Execution date of U.S. Patent Application
TOKYO, JAPAN Residence of fourth inventor	1
Masashi Uchille	Date of this assignment
Signature of fourth inventor	Date of this assument
Signature of fourth involuor	
	1.1/2 28 799
TAKUO MORIMURA  Name of fifth inventor	Execution date of U.S. Patent Application
KANAGAWA, JAPAN	Execution date of old. Fateur Application
Residence of fifth inventor	
Tikur morimura	Date of this assignment
Signature of fifth inventor	Date of this assignment
<del> </del>	
KAZIITAKA ANDO	Execution date of U.S. Patent Application
KAZUTAKA ANDO  Name of sixth invertor	Execution date of U.S. Patent Application
KANAGAWA, JAPAN	,
Residence of sigh inventor	T / 0 /00
Signature of sixth inventor	July 27, 55
Signature of sixth inventor	Date of this assignment
HIDEO NAKAYA	July 29, '99  Execution date of U.S. Patent Application
Name of seventh inventor	Execution date of U.S. Patent Application
KANAGAWA, JAPAN	
Residence of seventh inventor  Signature of seventh inventor	July 29, '99
Chidie Nakaya	/ <b>/</b>
Signature of seventh inventor	Date of this assignment
	$\epsilon_{i} \rightarrow \epsilon_{j}$
TSUTOMU WATANABE	Execution date of U.S. Patent Application
Name of eighth inventor	Execution date of U.S. Patent Application
KANAGAWA, JAPAN Residence of eighth inventor	
residence of eighth livemor	7 6 6 99
Signature of eighth inventor	Date of this assignment
organization organization of the second or t	
CAROCUT TNOUR	Aug 4 '99
SATOSHI INOUE  Name of ninth inventor	Execution date of U.S. Patent Application
KANAGAWA, JAPAN	
Residence of ninth inventor	0.0
Satorii Inone.	Aug. 4 '99
Signature of ninth inventor	Date of this assignment
WATARU NIITSUMA	Aug. 5. 99
Name of tenth inventor	Execution date of U.S. Patent Application
KANAGAWA, JAPAN	
Residence of tenth inventor	
Wataru Mitsuma	Aug. 5. '99
Signature of tenth inventor	Date of this assignment